

**Product data sheet** 

# 1. Product profile

## 1.1 General description

Hybrid amplifier module in a SOT115J package operating with a voltage supply of 24 V (DC).

### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features and benefits

- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability
- Excellent linearity

## 1.3 Applications

CATV systems operating in the frequency range of 40 MHz to 750 MHz

#### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	21	21.5	22	dB
		f = 750 MHz	21.5	22.5	-	dB
I <sub>tot</sub>	total current consumption (DC)	$V_B = 24 V$	[1] -	220	240	mA

<sup>[1]</sup> The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.



# 750 MHz, 21.5 dB gain push-pull amplifier

# 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Symbol
1	input		
2	common	1 3 5 7 9	5
3	common		$\frac{1}{2}$
5	+V <sub>B</sub>		
7	common		2 3 7 8 sym095
8	common		,
9	output	_	

# 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BGY787	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_i$	RF input voltage		-	60	dBmV
T <sub>stg</sub>	storage temperature		-40	+100	°C
T <sub>mb</sub>	mounting base temperature		-20	+100	°C

## 750 MHz, 21.5 dB gain push-pull amplifier

# 5. Characteristics

Table 5. Characteristics at bandwidth 40 MHz to 750 MHz

 $V_B=24~V;~T_{case}=30~^{\circ}C;~Z_S=Z_L=75~\Omega.$ 

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz		21	21.5	22	dB
		f = 750 MHz		21.5	22.5	-	dB
SL	slope cable equivalent	f = 40 MHz to 750 MHz		0	1	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 750 MHz		-	±0.2	±0.5	dB
s <sub>11</sub> input return losses	input return losses	f = 40 MHz to 80 MHz		20	33	-	dB
		f = 80 MHz to 160 MHz		18.5	30	-	dB
		f = 160 MHz to 320 MHz		17	25	-	dB
		f = 320 MHz to 640 MHz		15.5	22	-	dB
		f = 640 MHz to 750 MHz		14	20.5	-	dB
s <sub>22</sub> output return losses	f = 40 MHz to 80 MHz		20	28.5	-	dB	
		f = 80 MHz to 160 MHz		18.5	27.5	-	dB
		f = 160 MHz to 320 MHz		17	25	-	dB
		f = 320 MHz to 640 MHz		15.5	22	-	dB
		f = 640 MHz to 750 MHz		14	20	-	dB
ΨS21	phase response	f = 50 MHz		<b>-45</b>	-	+45	deg
СТВ	composite triple beat	110 channels flat; $V_0 = 44 \text{ dBmV}$ ; measured at 745.25 MHz		-	-54.5	-53	dB
$X_{mod}$	cross modulation	110 channels flat; $V_0 = 44 \text{ dBmV}$ ; measured at 55.25 MHz		-	<b>-54</b>	-52	dB
CSO	composite second order distortion	110 channels flat; $V_0 = 44 \text{ dBmV}$ ; measured at 746.5 MHz		-	-57.5	-53	dB
d <sub>2</sub>	second order distortion		[1]	-	-75	-63	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	[2]	61	63	-	dBmV
F	noise figure	f = 50 MHz		-	4	5	dB
		f = 450 MHz		-	-	5.5	dB
		f = 550 MHz		-	-	5.5	dB
		f = 600 MHz		-	-	6	dB
		f = 750 MHz		-	5	6.5	dB
I <sub>tot</sub>	total current consumption (DC)		[3]	-	220	240	mA

 $<sup>[1] \</sup>quad f_p = 55.25 \text{ MHz}; \ V_p = 44 \text{ dBmV}; \ f_q = 691.25 \text{ MHz}; \ V_q = 44 \text{ dBmV}; \ measured \ at \ f_p + f_q = 746.5 \text{ MHz}.$ 

<sup>[2]</sup> Measure according to DIN45004B;  $f_p = 740.25 \text{ MHz}; \ V_p = V_o; \ f_q = 747.25 \text{ MHz}; \ V_q = V_o - 6 \text{ dB}; \ f_r = 749.25 \text{ MHz}; \ V_r = V_o - 6 \text{ dB}; \ measured at \ f_p + f_q - f_r = 738.25 \text{ MHz}.$ 

<sup>[3]</sup> The module normally operates at  $V_B = 24 \ V$ , but is able to withstand supply transients up to 30 V.

## 750 MHz, 21.5 dB gain push-pull amplifier

Table 6. Characteristics at bandwidth 40 MHz to 770 MHz

 $V_B = 24 \ V; \ T_{case} = 30 \ ^{\circ}C; \ Z_S = Z_L = 75 \ \Omega.$ 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
G <sub>p</sub>	power gain	f = 50 MHz		21	21.5	22	dB
		f = 770 MHz		21.5	22.5	-	dB
SL	slope cable equivalent	f = 40 MHz to 770 MHz		0	1	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 770 MHz		-	±0.2	±0.5	dB
s <sub>11</sub> input return losses	f = 40 MHz to 80 MHz		20	33	-	dB	
		f = 80 MHz to 160 MHz		18.5	30	-	dB
		f = 160 MHz to 320 MHz		17	25	-	dB
		f = 320 MHz to 640 MHz		15.5	22.5	-	dB
		f = 640 MHz to 770 MHz		14	20.5	-	dB
S <sub>22</sub>	output return losses	f = 40 MHz to 80 MHz		20	28.5	-	dB
		f = 80 MHz to 160 MHz		18.5	27.5	-	dB
		f = 160 MHz to 320 MHz		17	25	-	dB
		f = 320 MHz to 640 MHz		15.5	22	-	dB
		f = 640 MHz to 770 MHz		14	20	-	dB
ΨS21	phase response	f = 50 MHz		<b>-45</b>	-	+45	deg
СТВ	composite triple beat	110 channels flat; $V_o = 44 \text{ dBmV}$ ; measured at 745.25 MHz		-	-54.5	-53	dB
$X_{mod}$	cross modulation	110 channels flat; $V_o = 44 \text{ dBmV}$ ; measured at 55.25 MHz		-	-54	-52	dB
CSO	composite second order distortion	110 channels flat; $V_o = 44 \text{ dBmV}$ ; measured at 746.5 MHz		-	-57.5	-53	dB
d <sub>2</sub>	second order distortion		[1]	-	-75	-63	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	[2]	61	63	-	dBmV
F	noise figure	f = 50 MHz		-	4	5	dB
		f = 450 MHz		-	-	5.5	dB
		f = 550 MHz		-	-	5.5	dB
		f = 600 MHz		-	-	6	dB
		f = 770 MHz		-	5	6.5	dB
I <sub>tot</sub>	total current consumption (DC)		[3]	-	220	240	mA

 $<sup>[1] \</sup>quad f_p = 55.25 \text{ MHz}; \ V_p = 44 \text{ dBmV}; \ f_q = 691.25 \text{ MHz}; \ V_q = 44 \text{ dBmV}; \ measured \ at \ f_p + f_q = 746.5 \text{ MHz}.$ 

<sup>[2]</sup> Measure according to DIN45004B;  $f_p = 740.25 \text{ MHz}; \ V_p = V_o; \ f_q = 747.25 \text{ MHz}; \ V_q = V_o - 6 \text{ dB}; \ f_r = 749.25 \text{ MHz}; \ V_r = V_o - 6 \text{ dB}; \ measured at \ f_p + f_q - f_r = 738.25 \text{ MHz}.$ 

<sup>[3]</sup> The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.

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Table 7. Characteristics at bandwidth 40 MHz to 600 MHz

 $V_B = 24 \ V; \ T_{case} = 30 \ ^{\circ}C; \ Z_S = Z_L = 75 \ \Omega.$ 

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz		21	21.5	22	dB
		f = 600 MHz		21.5	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 600 MHz		0	-	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 600 MHz		-	-	±0.3	dB
s <sub>11</sub>	input return losses	f = 40 MHz to 80 MHz		20	33	-	dB
		f = 80 MHz to 160 MHz		18.5	30	-	dB
		f = 160 MHz to 320 MHz		17	25	-	dB
		f = 320 MHz to 600 MHz		16	22.5	-	dB
S <sub>22</sub>	output return losses	f = 40 MHz to 80 MHz;		20	28.5	-	dB
		f = 80 MHz to 160 MHz		18.5	27.5	-	dB
		f = 160 MHz to 320 MHz		17	25	-	dB
		f = 320 MHz to 600 MHz		16	22	-	dB
<b>ΨS21</b>	phase response	f = 50 MHz		<b>-45</b>	-	+45	deg
СТВ	composite triple beat	85 channels flat; $V_o = 44 \text{ dBmV}$ ; measured at 595.25 MHz		-	-59.5	-58	dB
$X_{mod}$	cross modulation	85 channels flat; $V_o = 44 \text{ dBmV}$ ; measured at 55.25 MHz		-	-55.5	<b>-53</b>	dB
CSO	composite second order distortion	85 channels flat; $V_o = 44 \text{ dBmV}$ ; measured at 596.5 MHz		-	-64	-56	dB
d <sub>2</sub>	second order distortion		<u>[1]</u>	-	-	-68	dB
$V_{o}$	output voltage	$d_{im} = -60 \text{ dB}$	[2]	62.5	-	-	dBmV
F	noise figure	see <u>Table 5</u>		-	-	-	dB
I <sub>tot</sub>	total current consumption (DC)		[3]	-	220	240	mA

 $<sup>[1] \</sup>quad f_p = 55.25 \text{ MHz}; \ V_p = 44 \text{ dBmV}; \ f_q = 541.25 \text{ MHz}; \ V_q = 44 \text{ dBmV}; \ measured \ at \ f_p + f_q = 596.5 \text{ MHz}.$ 

<sup>[2]</sup> Measure according to DIN45004B;  $f_p = 590.25 \text{ MHz}; \ V_p = V_o; \ f_q = 597.25 \text{ MHz}; \ V_q = V_o - 6 \text{ dB}; \ f_r = 599.25 \text{ MHz}; \ V_r = V_o - 6 \text{ dB}; \ measured at } f_p + f_q - f_r = 588.25 \text{ MHz}.$ 

<sup>[3]</sup> The module normally operates at  $V_B = 24$  V, but is able to withstand supply transients up to 30 V.

## 750 MHz, 21.5 dB gain push-pull amplifier

Table 8. Characteristics at bandwidth 40 MHz to 550 MHz

 $V_B=24~V;~T_{case}=30~^{\circ}C;~Z_S=Z_L=75~\Omega.$ 

		A				
Symbol	Parameter	Conditions	Mii	1 Тур	Max	Unit
$G_p$	power gain	f = 50  MHz	21	21.5	22	dB
		f = 550 MHz	21.	5 -	-	dB
SL	slope cable equivalent	f = 40 MHz to 550 MHz	0	-	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 550 MHz	-	-	±0.3	dB
S <sub>11</sub>	input return losses	f = 40 MHz to 80 MHz	20	33	-	dB
		f = 80 MHz to 160 MHz	18.	5 30	-	dB
		f = 160 MHz to 320 MHz	17	25	-	dB
		f = 320 MHz to 550 MHz	16	22.5	-	dB
S <sub>22</sub>	output return losses	f = 40 MHz to 80 MHz	20	28.5	-	dB
		f = 80 MHz to 160 MHz	18.	5 27.5	-	dB
		f = 160 MHz to 320 MHz	17	25	-	dB
		f = 320 MHz to 550 MHz	16	22	-	dB
ΨS21	phase response	f = 50 MHz	-45	5 -	+45	deg
СТВ	composite triple beat	77 channels flat; $V_o = 44$ dBmV; measured at 547.25 MHz	-	<del>-</del> 61	-60	dB
$X_{mod}$	cross modulation	77 channels flat; $V_o = 44$ dBmV; measured at 55.25 MHz	-	-56.5	-55	dB
CSO	composite second order distortion	77 channels flat; $V_o = 44$ dBmV; measured at 548.5 MHz	-	-65.5	-58	dB
$d_2$	second order distortion		<u>[1]</u> _	-	-70	dB
$V_{o}$	output voltage	$d_{im} = -60 \text{ dB}$	<sup>[2]</sup> 63	-	-	dBmV
F	noise figure	see <u>Table 5</u>	-	-	-	dB
I <sub>tot</sub>	total current consumption (DC)		<u>[3]</u> _	220	240	mA

 $<sup>[1] \</sup>quad f_p = 55.25 \text{ MHz}; \ V_p = 44 \text{ dBmV}; \ f_q = 493.25 \text{ MHz}; \ V_q = 44 \text{ dBmV}; \ measured \ at \ f_p + f_q = 548.5 \text{ MHz}.$ 

<sup>[2]</sup> Measure according to DIN45004B;  $f_p = 540.25 \text{ MHz}$ ;  $V_p = V_o$ ;  $f_q = 547.25 \text{ MHz}$ ;  $V_q = V_o - 6 \text{ dB}$ ;  $f_r = 549.25 \text{ MHz}$ ;  $V_r = V_o - 6 \text{ dB}$ ; measured at  $f_p + f_q - f_r = 538.25 \text{ MHz}$ .

<sup>[3]</sup> The module normally operates at  $V_B = 24\ V$ , but is able to withstand supply transients up to 30 V.

## 750 MHz, 21.5 dB gain push-pull amplifier

Table 9. Characteristics at bandwidth 40 MHz to 450 MHz

 $V_B=24~V;~T_{case}=30~^{\circ}C;~Z_S=Z_L=75~\Omega.$ 

	, . case = 00 0, 25 = 2L = 10 121						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$G_p$	power gain	f = 50 MHz		21	21.5	22	dB
		f = 450 MHz		21.5	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 450 MHz		0	-	1.5	dB
FL	flatness of frequency response	f = 40 MHz to 450 MHz		-	-	±0.3	dB
s <sub>11</sub>	input return losses	f = 40 MHz to 80 MHz		20	33	-	dB
		f = 80 MHz to 160 MHz		18.5	30	-	dB
		f = 160 MHz to 320 MHz		17	25	-	dB
		f = 320 MHz to 450 MHz		16	22.5	-	dB
S <sub>22</sub>	output return losses	f = 40 MHz to 80 MHz		20	28.5	-	dB
		f = 80 MHz to 160 MHz		18.5	27.5	-	dB
		f = 160 MHz to 320 MHz		17	25	-	dB
		f = 320 MHz to 450 MHz		16	22	-	dB
ΨS21	phase response	f = 50 MHz		<del>-4</del> 5	-	+45	deg
СТВ	composite triple beat	60 channels flat; $V_o = 46 \text{ dBmV}$ ; measured at 445.25 MHz		-	-	<b>–59</b>	dB
$X_{mod}$	cross modulation	60 channels flat; $V_o = 46 \text{ dBmV}$ ; measured at 55.25 MHz		-	-	<b>–54</b>	dB
CSO	composite second order distortion	60 channels flat; $V_o = 46 \text{ dBmV}$ ; measured at 446.5 MHz		-	-	-60	dB
d <sub>2</sub>	second order distortion		<u>[1]</u>	-	-	-73	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	[2]	64	-	-	dBmV
F	noise figure	see <u>Table 5</u>		-	-	-	dB
I <sub>tot</sub>	total current consumption (DC)		[3]	-	220	240	mA

 $<sup>[1] \</sup>quad f_p = 55.25 \text{ MHz}; \ V_p = 46 \text{ dBmV}; \ f_q = 391.25 \text{ MHz}; \ V_q = 46 \text{ dBmV}; \ measured \ at \ f_p + f_q = 446.5 \text{ MHz}.$ 

<sup>[2]</sup> Measure according to DIN45004B;  $f_p = 440.25 \text{ MHz}$ ;  $V_p = V_o$ ;  $f_q = 447.25 \text{ MHz}$ ;  $V_q = V_o - 6 \text{ dB}$ ;  $f_r = 449.25 \text{ MHz}$ ;  $V_r = V_o - 6 \text{ dB}$ ; measured at  $f_p + f_q - f_r = 438.25 \text{ MHz}$ .

<sup>[3]</sup> The module normally operates at  $V_B = 24$  V, but is able to withstand supply transients up to 30 V.

### 750 MHz, 21.5 dB gain push-pull amplifier

# 6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J

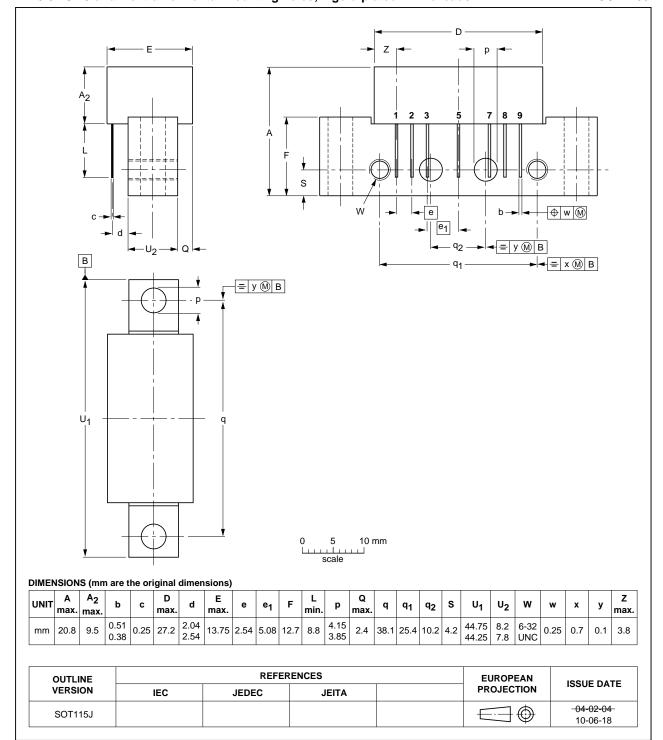


Fig 1. Package outline SOT115J

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# 750 MHz, 21.5 dB gain push-pull amplifier

# 7. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGY787 v.9	20110919	Product data sheet	-	BGY787 v.8
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the ne	ew company name whe	ere appropriate.
	<ul> <li>Package out</li> </ul>	ıtline drawings have been up	odated to the latest vers	sion.
BGY787 v.8 (9397 750 14773)	20050401	Product data sheet	-	BGY787 v.7
BGY787 v.7 (9397 750 11198)	20030516	Product specification	-	BGY787 v.6
BGY787 v.6 (9397 750 08811)	20011031	Product specification	-	BGY787 v.5
BGY787 v.5 (9397 750 05455)	19990330	Product specification	-	BGY787 v.4
BGY787 v.4 (9397 750 02951)	19971124	Product specification	-	BGY787 v.3
BGY787 v.3 (9397 750 02155)	19970414	Product specification	-	-

# 750 MHz, 21.5 dB gain push-pull amplifier

# 8. Legal information

#### 8.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BGY787

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## 750 MHz, 21.5 dB gain push-pull amplifier

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Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.